

# **SPECIFICATION**

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SPEC. NO.: PS-50376-XXXXX REVISION: K

PRODUCT NAME: 0.6mm PITCH WTB IDC CONNECTOR

**PRODUCT NO:** 50376 \ 50476 \ \ 50499 \ \ 51300 \ \ 51376 \ SERIES

PREPARED: CHECKED: APPROVED:

GUOFEI BRAVE BRAVE

DATE: DATE:

2020/07/15 2020/07/15 2020/07/15



**51300** series

TITLE: 0.6mm PITCH WTB IDC CONNECTOR

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# 1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
0	ECN-1003221	PRODUCT RELEASE FOR APD980361	STANLEY	2010.03.25
Α	ECN-1104189	ADD AWG#34	BRUCE	2011.04.25
В	ECN-1112095	DELETE AWG#34	GAVIN	2011.12.09
С	ECN-1204426	MODIFY CURRENT	BRAVE	2012.04.26
D	ECN-1304034	ADD AWG#34 & Add 51224 51223 50497 Series	Warles	2013.04.01
Е	ECN-1305292	ADD 50476 series	Warles	2013.05.23
F	ECN-1401180	ADD 50499 Series	XUFEI	2014.01.10
G	ECN-1507009	ADD 51300 Series	ZHUWEI	2015.04.10
Н	ECN-1507351	ADD 16pin INSERTION/EXTRACTION FORCE	ZHUWEI	2015.07.23
J	ECN-1903436	ADD 51376 Series	JINTAO	2019/01/10
K	ECN-2005307	ADD Salt Spray (Gold plating 3 u" for 48 hours).	GUOFEI	2020/07/15



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#### 2 SCOPE

This specification covers performance, tests and quality requirements for 0.6 mm pitch WTB IDC connector.

#### 3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

#### **4 REQUIREMENTS**

4.1 Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable product drawing.

- 4.2 Materials and Finish
  - 4.2.1 Terminal: High performance copper alloy (Phosphor Bronze)
    - Plated: (a) Finish: Refer to the drawing.
      - (b) Under plate: Refer to the drawing.
  - 4.2.2 Housing: Thermoplastic, High temp. UL94V-0
  - 4.2.3 Fitting: High performance copper alloy
    - Plated: (a) Finish: Refer to the drawing.
      - (b) Under plate: Refer to the drawing.
- 4.3 Ratings
  - 4.3.1 Voltage: 30 Volts DC
  - 4.3.2 Current:

DC 0.50 Amperes (per pin) AWG# 34(51224  $\times$  50497) Insulation O.D  $\varphi$  0.32mm DC 0.50 Amperes (per pin) AWG# 36(51223  $\times$  50476) Insulation O.D  $\varphi$  0.29mm

4.3.3 Operating Temperature : -40 □ to +85 □



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## 5 Performance

## 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard						
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.						
	ELECTRICAL							
Item	Requirement	Standard						
Low Level Contact Resistance	Initial: $30 \text{ m } \Omega$ max. After Test: $50 \text{ m } \Omega$ max.	Mate connectors and measure by dry circuit, 20m V max. 10m A (EIA-364-23)						
Insulation Resistance	100 M Ω Min.	Unmated connectors, apply 100 V DC between adjacent terminals. (EIA-364-21)						
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	200V AC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)						
Temperature Rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70 METHOD 1,CONDITION 1)						
	MECHANICAL							
Item	Item Requirement Standard							
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min.						
Insertion /Extraction Forces (Mating/ Un-mating Force)	See item 8	Operation Speed:  25.4 ± 3 mm/minute  Measure the force required to mate/unmate connector. (EIA-364-13)						
Wire Pull Out Force	See item 10	Operation Speed: 25.4 ± 3 mm/minute. Fix the crimped terminal, apply axial pull out force on the wire.						
Terminal/Housing Retention force (Board Side)	70g Min.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.						



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Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)
	ENVIRONMENTAL	_
Item	Requirement	Standard
Humidity	See Product Qualification and Test Sequence Group 6	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)
Thermal Shock	See Product Qualification and Test Sequence Group 6	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 7	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 3 u" for 48 hours. (III) Gold plating 5 u" for 96 hours. (EIA-364-26)
Solder ability (Board Side)	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating:	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)



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	minimum of 75% solder coverage	
Resistance to <b>Reflow</b> Soldering Heat (Board Side)	See Product Qualification and Test	Pre Heat: 150°C ~180°C, 60~120sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max.
Hand Soldering Temperature Resistance (Board Side)	Appearance: No damage	T≧350°C, 3sec at least.

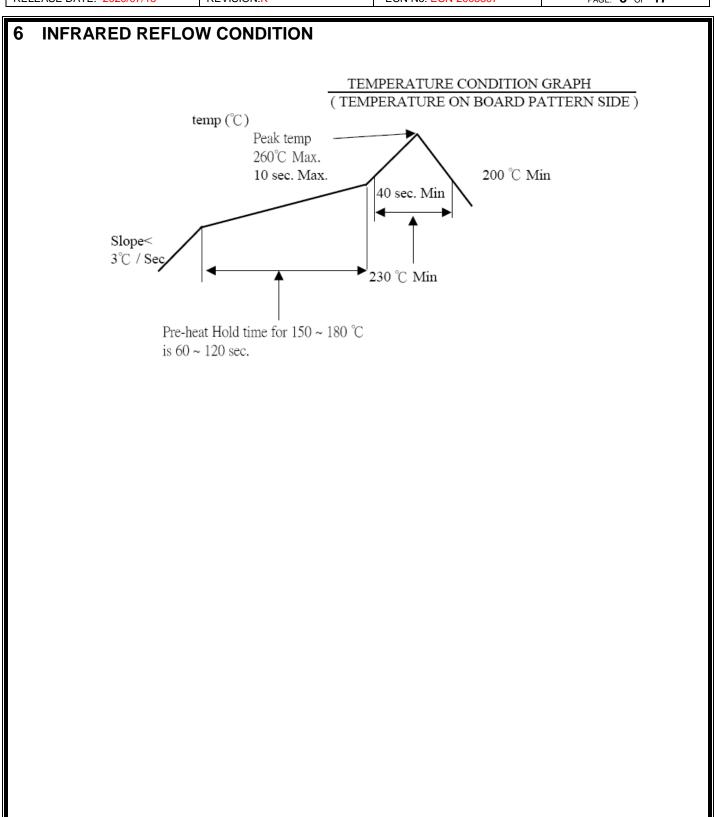
Note. Flowing Mixed Gas shell be conduct by customer request.



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## 7 PRODUCT QUALIFICATION AND TEST SEQUENCE

					Te	est Gro	up				
Test or Examination	1	2	3	4	5	6	7	8	9	10	11
					Tes	t Seque	ence				
Examination of Product		1、6	2	2		1 . 7	1 \ 4		1、3	1	
Contact Resistance		2 \ 7			1 \ 4	2、10	2 \ 5		4		
Insulation Resistance						3 . 9					
Dielectric Strength						4 · 8					
Temperature Rise	1										
Insertion /Extraction Forces		3 ` 5									
Wire pull out Forces			1								
Terminal/Housing Extraction Forces				1							
Vibration					2						
Shock					3						
Humidity						5					
Thermal Shock						6					
Solder ability								1			
Resistance to Soldering Heat (Board Side)									2		
Salt Spray (Only For Gold Plating)							3				
Durability		4									
Hand Soldering Temperature Resistance (Board Side)										2	
Sample Size	2	4	4	4	4	4	4	2	4	4	



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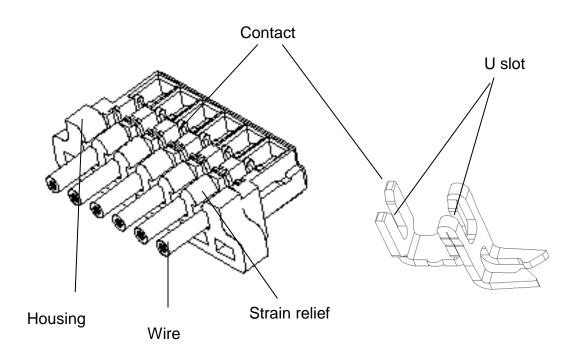
TITLE: 0.6mm PITCH WTB IDC CONNECTOR

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### 8 INSERTION / EXTRACTION FORCE

	Ini	tial	After 30 <sup>th</sup> Cycle
NO. OF Ckt.	Insertion Force (Max.)	Withdrawal Force (Min.)	Withdrawal Force (Min)
4~7	1.4 Kgf	0.2 Kgf	0.15 Kgf
8~16	2.0 Kgf	0.35 Kgf	0.25 Kgf

## 9 APPLICABLE SPECIFICATIONS



51224 · 51223 Series



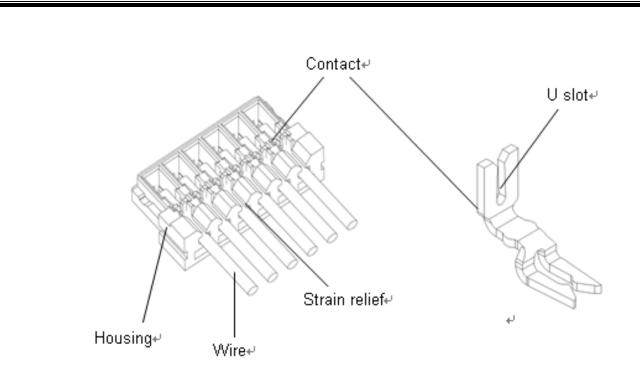
It is

Aces P/N: 50376 series 50476 series 50499 series

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**50476** • 50497 Series

## 10 CONTACT V.S WIRE RETENTION FORCE

Wire Size	UL style (REF.)	Material of insulation	Insulation OD	Parallel	Perpendicular
AWG#36 (51223 \ 50476)	UL10064	Teflon/PTFE	Ф0.29±0.02mm	300gf Min.	100gf Min.
AWG#34 (51224 \ 50497)	UL10064	Teflon/PTFE	Ф0.32±0.02mm	300gf Min.	100gf Min.

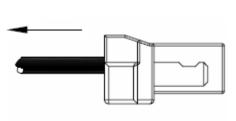
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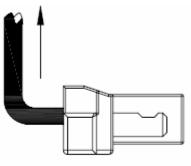
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Parallel direction



Perpendicular direction

#### 11 TERMINATION DEPTH

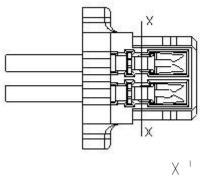


Fig.-1

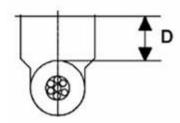


Fig.-2

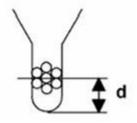


Fig.-3

Measure termination depth dimension "D" in Fig.-2 at X-X part in Fig.-1 where is in then middle part of two U slots and a flattened part pressed by termination punch, and check it satisfies specified value in table

Exact termination depth is measure "d" between bottom of slot and position of center core wire of wire conductors as shown in Fig.-3; Aces specifies termination depth dimension "D" force to facilitate a time-consuming work of measuring "d" as a daily control.

Accordingly, dimension "D" becomes not reference value but control value for the use of the wire to be checked is Aces expect specified wires.



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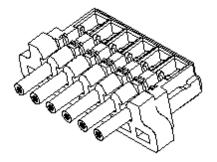
Wire Size	UL style (REF.)	Insulation OD	Termination Depth D	d
AWG#36 (51223 \ 50476 Series)	UL10064	Ф0.29±0.02mm	D=0.31±0.05mm	d=0.15±0.05mm
AWG#34 (51224 \ 50497 Series)	UL10064	Ф0.32±0.02mm	D=0.28±0.05mm	d=0.16±0.05mm

#### 12 ERMINATION APPEARANCE

Inspect the following points after termination.

- 12.1 Punching flaws on housing caused by termination punch; Housing must be free from flaws. When connector set position deviation, scratches and deformation caused by termination punch may appear at the diagonally shaded areas in Fig.-4.
- 12.2 Flaws and deformation at beams of contact. Beams must be free from flaws and dimension. When connector set position deviation to wire axis direction, scratches and deformation caused by termination punch may appear at beams of contact as shown in Fig.-5.

In this case, not only contact but also termination die may be damaged.



51224 \ 51223

50497 \ 50476

Fig.-4 Fig.-5



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12.3 Exposure of wire conductors around beams of contact; Wire conductors must not be exposed. When connector set position deviates to wire axis direction, wire conductors may expose in front or back of beams of contact as shown in Fig.-6.

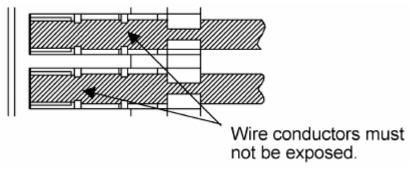


Fig.-6

12.4 Gap between housing wall and wire tip (Wire protruding length) Gap "G" between housing walls and wires tip in Fig.-7 should be 0.2 mm max.

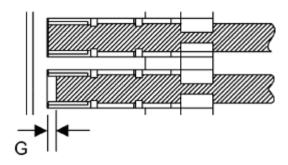
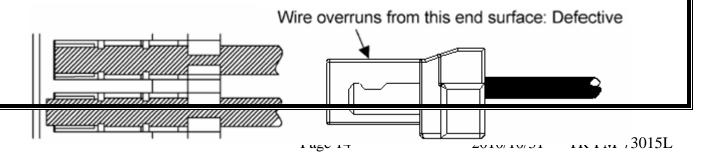


Fig.-7

12.5 Overrun of wire (Wire must not overrun) when wire tension is not adequate, overrun of wire may appear as shown in Fig.-8.



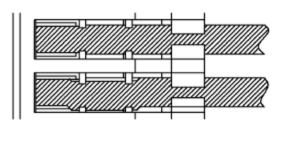


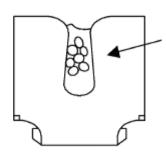
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Fig.-8

12.6 Deviation of insulation displacement center (Deviation of insulation displacement center must not happen. When connector set position or wire deviates to pitch direction, termination punch, wire and U slots do not align so that insulation displacement center deviate as shown in Fig.-9 and Fig.-10





Wire conductors do not contact with the right side of U slot.

Fig.-9

Fig.-10

#### 13 MATING/UNMATING METHOD CONNECTOR

13.1 Mating method of connector

Mated receptacle with header straight on same axis. When the position of mating part of header and receptacle is aligned, align one side of mating part of header with the end of receptacle within 20 degrees to mating axis as shown in Fig.-11.

Do not mate receptacle at the angle of 20 degrees or more, because such handling may cause breakage of connector, etc.

When position of receptacle and header is aligned, hold wires in a bundle in order to prevent applying external force to receptacle. Then, mate receptacle with header up to the back straight against mating axis.

Besides, after mating operation, check that there is no clearance between header and receptacle as shown in Fig.-12, because such clearance may lead discontinuity of connector.



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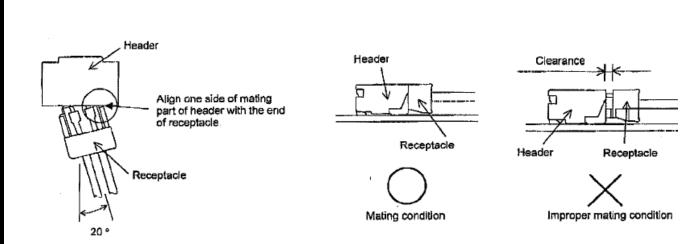


Fig.-11
Align the position (Side entry type)

Fig.-12
Mating condition (Side entry type)

### 13.2 Unmating method of connector

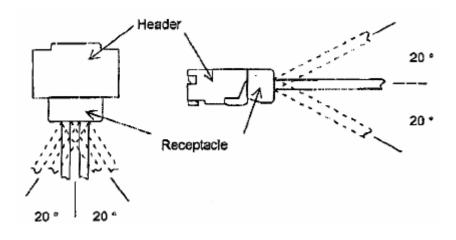
Hold wires in a bundle and unmate receptacle from header on the same axis. At this time, conduct operation within 20 degrees to mating axis.

Do not unmate receptacle forcibly with prying more than 20 degrees, because such handing may cause breakage of connector, etc.

If receptacle is unmated with holding wire of only one end, such handling is the same as prying connector.

Beside, there is a possibility that wire may come off housing when they are unmated without holding in a bundle.

Even when all wires cannot be held in routing of wires, wire more than the number shown in the Table-1 should be held and unmated.





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Fig.-13

CKTS	Wires
2	hold 2 wires without fail
3~5	hold more than 3 wires
6~10	hold more than 4 wires
11~15	hold more than 5wires
16~20	hold more than 6 wires

Table -1

## 13.3 Routing of wire

In routing wire, careful operation is required so that tension more than 1N may not be applied per connector and one wire (one circuit).